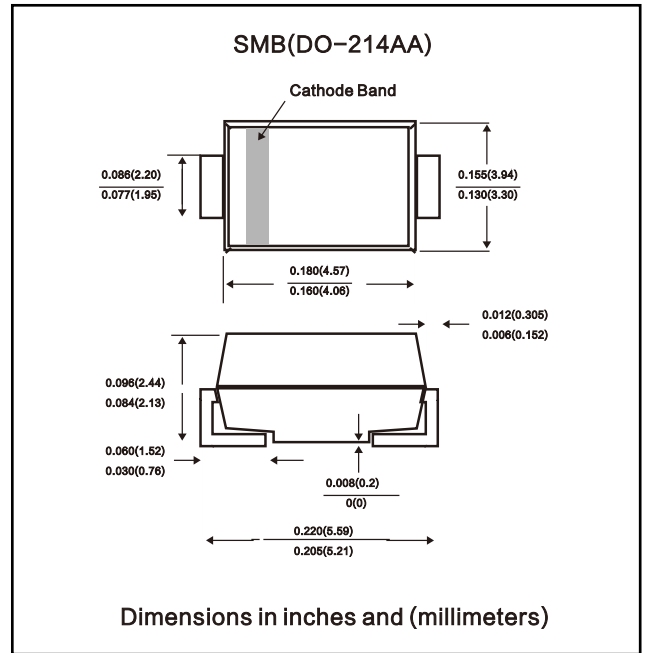


FEATURES

- Glass Passivated Die Construction
- Fast Recovery Time For High Efficiency
- Low Forward Voltage Drop and High Current Capability
- Surge Overload Rating to 30A Peak
- Ideally Suited for Automated Assembly
- Plastic Material: UL Flammability Classification Rating 94V-0

Mechanical Data

- Case: Molded Plastic
- Terminals: Solder Plated Terminal - Solderable per MIL-STD-202, Method 208
- Polarity: Cathode Band or Cathode Notch
- SMA Weight: 0.064 grams (approx.)
- SMB Weight: 0.093 grams (approx.)
- Mounting Position: Any
- Marking: Type Number



MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

		RS3A	RS3B	RS3D	RS3G	RS3J	RS3K	RS3M	UNTS
Maximum recurrent peak reverse voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V_{RMS}	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	V_{DC}	50	100	200	400	600	800	1000	V
Maximum average forward rectified current at $T_L=90^{\circ}C$	$I_{F(AV)}$	3.0							A
Peak forward surge current @ $T_L = 110^{\circ}C$ 8.3ms single half-sine-wave superimposed on rated load	I_{FSM}	1000							A
Maximum instantaneous forward voltage at 3.0A	V_F	1.30							V
Maximum DC reverse current @ $T_A=25^{\circ}C$ at rated DC blocking voltage @ $T_A=125^{\circ}C$	I_R	5.0 200.0							μA
Maximum reverse recovery time (NOTE 1)	t_{rr}	150			250		500		ns
Typical junction capacitance (NOTE 2)	C_J	32							pF
Typical thermal resistance (NOTE 3)	$R_{\theta JA}$	40.0							$^{\circ}C/W$
Operating junction and storage temperature range	$T_J T_{STG}$	-55 to +150							$^{\circ}C$

NOTE: 1.Reverse recovery time test conditions: $I_F=0.5A, I_R=1.0A, I_{rr}=0.25A$
 2. Measured at 1.0MHz and applied reverse voltage of 4.0 Volts
 3. Thermal resistance from junction to ambient and junction to lead P.C.B.mounted on 0.2"X0.2"(5.0X5.0mm²) copper pad areas

FIG.1 -- FORWARD DERATING CURVE

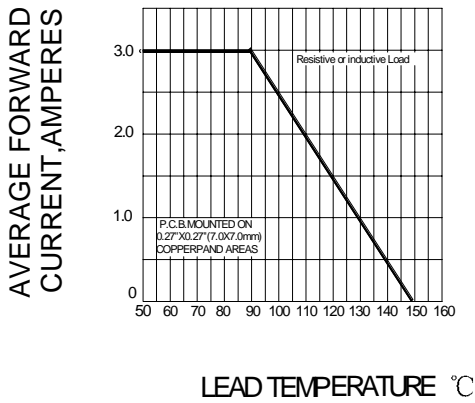


FIG.2 PEAK FORWARD SURGE CURRENT

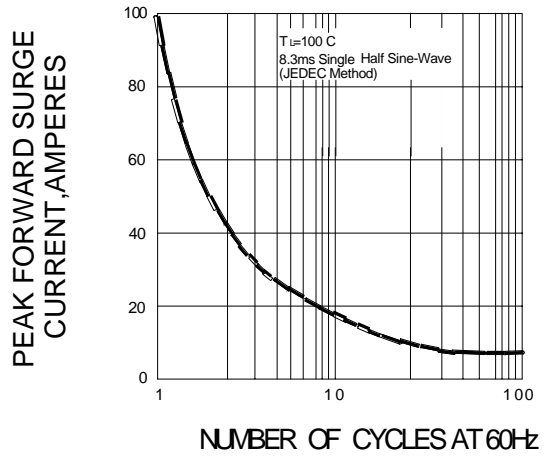


FIG.3 -- TYPICAL FORWARD CHARACTERISTICS

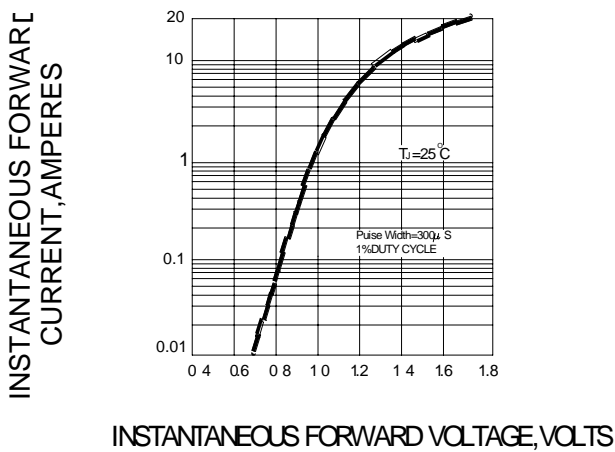


FIG.4 -- TYPICAL REVERSE CHARACTERISTICS

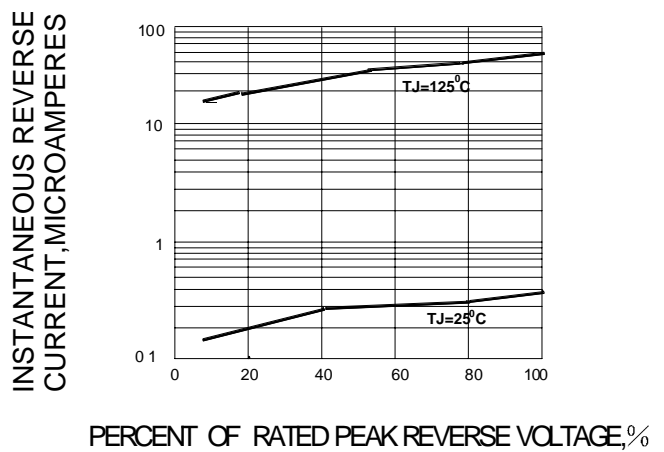


FIG.5-TYPICAL JUNCTION CAPACITANCE

